

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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YINGYING HUANG	12/06/2017
WEI SHAN LIM	12/06/2017
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State/Country:	SINGAPORE
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15559755
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	690148.529USPC
NAME OF SUBMITTER:	HAI HAN, PH.D.
SIGNATURE:	/Hai Han/
DATE SIGNED:	12/13/2017
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, we, Subramaniam Venkatraman, Yingying Huang, and Wei Shan Lim (hereinafter referred to as ASSIGNORS), having a mailing address c/o Nanyang Technological University, 50 Nanyang Avenue, Singapore, Singapore, 639798, are the joint inventors of an invention entitled "A STENT ASSEMBLY AND METHOD OF PREPARING THE STENT ASSEMBLY," as described and claimed in the specification for which an application for United States letters patent was filed on September 19, 2017 and assigned Application No. 15/559,755; which application is a national stage application filed under 35 U.S.C. 371 of International Application No. PCT/SG2016/050119, accorded an International Filing Date of March 15, 2016;

WHEREAS, Nanyang Technological University (hereinafter referred to as ASSIGNEE), having a usual place of business at 50 Nanyang Avenue, Singapore, Singapore, 639798, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions including any extensions or adjustments in term thereof, and in any and all divisions, reissues and continuations thereof, including the right to sue and collect damages for past and present infringement of said letters patent; said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

International Application No.: PCT/SG2016/050119
U.S. Application No.: 15/559,755

6th Dec 2017
Date



Subramaniam Venkatraman

I certify that I know or have satisfactory evidence that Subramaniam Venkatraman signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

Date 06/12/17
(Type or Print)

Signed at School of Material Science & Engineering, NTU

ANJANANT NG
(Type or Print Name of Witness)


(Signature of Witness)

International Application No.: PCT/SG2016/050119
U.S. Application No.: 15/559,755

YH

6th Dec 2017

Date

Yingying Huang

I certify that I know or have satisfactory evidence that Yingying Huang signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

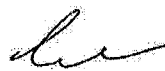
Date 06/12/17
(Type or Print)

ANTHONY NG
(Type or Print Name of Witness)

Signed at School of Materials Science & Engineering, NTU

AN
(Signature of Witness)

6th Dec 2017
Date


Wei Shan Lim

I certify that I know or have satisfactory evidence that Wei Shan Lim signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

Date 06/12/17
(Type or Print)

Signed at School of Materials Science & Engineering NTU

ANTHONY NG
(Type or Print Name of Witness)


(Signature of Witness)

(690148.529USPC) Docket No.
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